Advanced Low Power Schottky Logic – 54ALS93

4-bit Binary Counter Logic IC in bare die form

Description

The 54ALS93 4-bit binary counter is fabricated using a 2µm 40V bipolar process. The device comprises two 4-bit ripple type counters consisting of four master-slave flip-flops internally connected to provide a divide-by-two section and a divide-by-eight section. Each section has independent clock (CK) & asynchronous master reset (R0) inputs. Counter state change is triggered by a high-to-low transition on the clock. Each section can be used separately or tied together (Q to CK) to form BCD or modulo-16 counters.

Features:

Die Din

- Low Power Consumption
- Input Clamp Diodes Limit High Speed Termination Effects
- Full Military Temperature Range
- Direct drop-in replacement for obsolete components in long-term programs.

sions in µm (mils)

1600 (63)

Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-883 /2010B Visual Inspection
- "H" MIL-STD-883 /2010B Visual Inspection + MIL-PRF-38534 Class H LAT
- "K" MIL-STD-883 /2010A Visual Inspection (Space)
 + MIL-PRF-38534 Class K LAT
- LAT = Lot Acceptance Test.

For further information on LAT process pows see below.

www.siliconsupplies.com\quality.na/e-die-lot-qualification

Supply Formats

- Defact Die in Waffle Pack (100 per tray capacity)
- Sawn Wafer on Tape On request
- Unsawn Wafer On request
- Die Thickness <> 350µm(14 Mils) On request
- Assembled into Ceramic Package On request

Mechanical Specification

Die Size (Unsawn)	1600 x 1600 63 x 63	µm mils	
Minimum Bond Pad Size	130 x 130 5.12 x 5.12	µm mils	
Die Thickness	350 (±20) 13.78 (±0.79)	µm mils	
Top Metal Composition	Al 1%Si 1.1µm		
Back Metal Composition	N/A – Bare Si		



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600 (63)



Pad Layout and Functions

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Absolute Maximum Ratings¹

PARAMETER	SYMBOL	VALUE	UNIT
DC Supply Voltage (Referenced to GND)	V _{CC}	7.0	V
DC Input Voltage (Referenced to GND)	V _{IN}	7.0	
Storage Temperature Range	T _{STG}	-65 to 150	<u> </u>

1. Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for exampled periods, may reduce device reliability.

Recommended Operating Conditions

PARAMETER	SYMBOL	MIN	MAX	UNITS
Supply Voltage (Referenced to GND)	V _{CC}	4.5	5.5	
High-Level Input Voltage	V _{IH}	2		V
Low-Level Input Voltage	V _{IL}	-	0.9	V
High-Level Output Current	I _{ОН}	-	-0.4	mA
Low-Level Output Current	I _{OL}	-	8	mA
Operating Temperature Range	TJ	-55 🥒	+125	°C

DC Electrical Characteristics Voltages referenced to GND, TJ = -55°C to 125°C unless otherwise specified

PARAMETER	SYMBOL CONDITIONS	LIMITS				
		MIN	TYP	MAX	GITTS	
Minimum High-Level Input Voltage	V _{IH}	· ·	2	-	-	V
Maximum Low-Level Input Voltage	VIL	-	-	-	0.8	V
Input Clamp Diode Voltage		V _{CC} = 4.5V I _{IN} = -18mA	-	-0.65	-1.5	V
Output Voltage High	√он	V _{CC} = 4.5V, I _{OH} = -0.4mA	V _{CC} -2	-	-	V
Output Voltage Ltw	V _{OL}	V _{CC} = 4.5V, I _{OL} = 4mA	-	0.25	0.4	V
		V_{CC} = 4.5V, I _{OL} = 8mA	-	0.35	0.5	
Inpat High Current	$I_{\rm IH} = \frac{V_{\rm CC} = 5.5V}{V_{\rm CC} = 5.5V}$	V_{CC} = 5.5V, V_{IN} = 2.7V	-	-	20	μA
		$V_{CC} = 5.5V, V_{IN} = 7.0V$	-	-	0.1	mA
Input Low Current	IIL	$V_{CC} = 5.5 V, V_{IL} = 0.4 V$	-	-	-0.1	mA
Short Circuit Current ²	I _{OS}	V_{CC} = 5.5V, V_{OUT} = 2.25V	-30	-	-112	mA
Supply Current	I _{CC}	V _{CC} = 5.5V	-	-	13	mA

2. Not more than one output should be shorted at a time, nor for more than 1 second.



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AC Electrical (Characte	ristics ⁴ v _{cc} = 5v, T _J = -55	°C to 125°C unl	ess otherwise sp	ecified	Rev 1.1 28/08/21
PARAMETER	SYMBOL	CONDITIONS				
			MIN	TYP	MAX	
Input Clock Frequency, CK _A	f		32	-		MHz
Input Clock Frequency, CK _B	'max	$C_{L} = 50 \text{pF}, R_{L} = 510 \Omega$	16	-		MHz
Fall, Rising Edge	t _f , t _r		-	- /	2	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{A}} \text{ to } \text{Q}_{\text{A}} \end{array}$	t _{PLH}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	-		16	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{A}} \text{ to } \text{Q}_{\text{A}} \end{array}$	t _{PHL}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	-	, O`	18	
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{A}} \text{ to } \text{Q}_{\text{D}} \end{array}$	t _{PLH}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	- <u> </u> C	V -	70	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{A}} \text{ to } \text{Q}_{\text{D}} \end{array}$	t _{PHL}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	0,	-	70	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{B}} \text{ to } \text{Q}_{\text{B}} \end{array}$	t _{PLH}	C _L = 50pF, R _L = 510Ω	-	-	16	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{B}} \text{ to } \text{Q}_{\text{B}} \end{array}$	t _{PHL}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	-	-	21	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{B}} \text{ to } \text{Q}_{\text{C}} \end{array}$	t _{PLH}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	-	-	32	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{B}} \text{ to } \text{Q}_{\text{C}} \end{array}$	t _{PHL}	C _L = 50pF, R _L = 510Ω	-	-	35	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{B}} \text{ to } \text{Q}_{\text{D}} \end{array}$	t _{PLH}	$S_L = 50 \text{pF}, R_L = 510 \Omega$	-	-	51	ns
$\begin{array}{c} \text{Propagation Delay,} \\ \text{CK}_{\text{B}} \text{ to } \text{Q}_{\text{D}} \end{array}$	PHL	$C_{L} = 50 pF, R_{L} = 510 \Omega$	-	-	51	ns
Propagation Delay, R0 to any output	t _{PHL}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	-	-	32	ns

Timing Requirements⁴ $V_{CC} = 5V$, $T_J = -55^{\circ}C$ to 125°C unless otherwise specified

PARAMETER	SYMBOL COND	CONDITIONS		LIMITS	UNITS	
	OTMEOL	CONDITIONO	MIN	TYP	MAX	
CK _A Pulse Width	t _w	$C_{L} = 50 pF, R_{L} = 510 \Omega$	15	-	-	ns
CK _B Pulse Width			30	-	-	ns
R0 Pulse Width			15	-	-	ns
Recovery Time, R0 to CK	t _{REC}	$C_{L} = 50 pF, R_{L} = 510 \Omega$	25	-	-	ns

4. Not production tested in die form, characterized by chip design.



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Switching Waveforms



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* Includes all probe and jig capacitance

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